

## 100V N-Ch Power MOSFET

### Feature

- ◇ High Speed Power Switching
- ◇ Enhanced Body diode dv/dt capability
- ◇ Enhanced Avalanche Ruggedness
- ◇ 100% UIS Tested, 100% Rg Tested
- ◇ Lead Free, Halogen Free

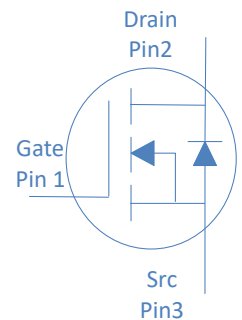
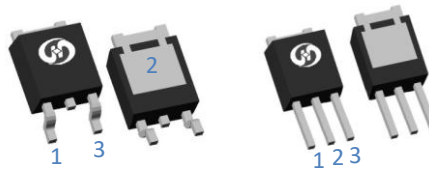
|                         |     |            |
|-------------------------|-----|------------|
| $V_{DS}$                | 100 | V          |
| $R_{DS(on),typ}$        | 8.8 | m $\Omega$ |
| $I_D$ (Silicon Limited) | 67  | A          |

### Application

- ◇ Synchronous Rectification in SMPS
- ◇ Hard Switching and High Speed Circuit
- ◇ DC/DC in Telecoms and Industrial

TO-252

TO-251



| Part Number | Package | Marking   |
|-------------|---------|-----------|
| HGD098N10A  | TO-252  | GD098N10A |
| HGI098N10A  | TO-251  | GI098N10A |

### Absolute Maximum Ratings at $T_J=25^\circ\text{C}$ (unless otherwise specified)

| Parameter                                  | Symbol         | Conditions                             | Value      | Unit             |
|--------------------------------------------|----------------|----------------------------------------|------------|------------------|
| Continuous Drain Current (Silicon Limited) | $I_D$          | $T_C=25^\circ\text{C}$                 | 67         | A                |
|                                            |                | $T_C=100^\circ\text{C}$                | 48         |                  |
| Drain to Source Voltage                    | $V_{DS}$       | -                                      | 100        | V                |
| Gate to Source Voltage                     | $V_{GS}$       | -                                      | $\pm 20$   | V                |
| Pulsed Drain Current                       | $I_{DM}$       | -                                      | 190        | A                |
| Avalanche Energy, Single Pulse             | $E_{AS}$       | $L=0.1\text{mH}, T_C=25^\circ\text{C}$ | 31         | mJ               |
| Power Dissipation                          | $P_D$          | $T_C=25^\circ\text{C}$                 | 94         | W                |
| Operating and Storage Temperature          | $T_J, T_{stg}$ | -                                      | -55 to 175 | $^\circ\text{C}$ |

### Absolute Maximum Ratings

| Parameter                           | Symbol          | Max | Unit               |
|-------------------------------------|-----------------|-----|--------------------|
| Thermal Resistance Junction-Ambient | $R_{\theta JA}$ | 50  | $^\circ\text{C/W}$ |
| Thermal Resistance Junction-Case    | $R_{\theta JC}$ | 1.6 | $^\circ\text{C/W}$ |

**Electrical Characteristics at  $T_j=25^{\circ}\text{C}$  (unless otherwise specified)**
**Static Characteristics**

| Parameter                         | Symbol        | Conditions                                        | Value |     |           | Unit      |
|-----------------------------------|---------------|---------------------------------------------------|-------|-----|-----------|-----------|
|                                   |               |                                                   | min   | typ | max       |           |
| Drain to Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=250\mu A$                         | 100   | -   | -         | V         |
| Gate Threshold Voltage            | $V_{GS(th)}$  | $V_{GS}=V_{DS}, I_D=250\mu A$                     | 2.0   | 3.0 | 4.0       |           |
| Zero Gate Voltage Drain Current   | $I_{DSS}$     | $V_{GS}=0V, V_{DS}=100V, T_j=25^{\circ}\text{C}$  | -     | -   | 1         | $\mu A$   |
|                                   |               | $V_{GS}=0V, V_{DS}=100V, T_j=100^{\circ}\text{C}$ | -     | -   | 100       |           |
| Gate to Source Leakage Current    | $I_{GSS}$     | $V_{GS}=\pm 20V, V_{DS}=0V$                       | -     | -   | $\pm 100$ | nA        |
| Drain to Source on Resistance     | $R_{DS(on)}$  | $V_{GS}=10V, I_D=20A$                             | -     | 8.8 | 9.8       | $m\Omega$ |
| Transconductance                  | $g_{fs}$      | $V_{DS}=5V, I_D=20A$                              | -     | 39  | -         | S         |
| Gate Resistance                   | $R_G$         | $V_{GS}=0V, V_{DS}$ Open, $f=1\text{MHz}$         | -     | 1.5 | -         | $\Omega$  |

**Dynamic Characteristics**

|                               |              |                                                  |   |      |   |      |
|-------------------------------|--------------|--------------------------------------------------|---|------|---|------|
| Input Capacitance             | $C_{iss}$    | $V_{GS}=0V, V_{DS}=50V, f=1\text{MHz}$           | - | 1326 | - | $pF$ |
| Output Capacitance            | $C_{oss}$    |                                                  | - | 262  | - |      |
| Reverse Transfer Capacitance  | $C_{rss}$    |                                                  | - | 7.7  | - |      |
| Total Gate Charge             | $Q_g(10V)$   | $V_{DD}=50V, I_D=20A, V_{GS}=10V$                | - | 23   | - | $nC$ |
| Gate to Source Charge         | $Q_{gs}$     |                                                  | - | 5.5  | - |      |
| Gate to Drain (Miller) Charge | $Q_{gd}$     |                                                  | - | 6.5  | - |      |
| Turn on Delay Time            | $t_{d(on)}$  | $V_{DD}=50V, I_D=20A, V_{GS}=10V, R_G=10\Omega,$ | - | 6    | - | $ns$ |
| Rise time                     | $t_r$        |                                                  | - | 3    | - |      |
| Turn off Delay Time           | $t_{d(off)}$ |                                                  | - | 17   | - |      |
| Fall Time                     | $t_f$        |                                                  | - | 4    | - |      |

**Reverse Diode Characteristics**

|                         |          |                                        |   |     |     |    |
|-------------------------|----------|----------------------------------------|---|-----|-----|----|
| Diode Forward Voltage   | $V_{SD}$ | $V_{GS}=0V, I_F=20A$                   | - | 0.9 | 1.2 | V  |
| Reverse Recovery Time   | $t_{rr}$ | $V_R=50V, I_F=20A, di_F/dt=500A/\mu s$ | - | 52  | -   | ns |
| Reverse Recovery Charge | $Q_{rr}$ |                                        | - | 176 | -   | nC |

Fig 1. Typical Output Characteristics

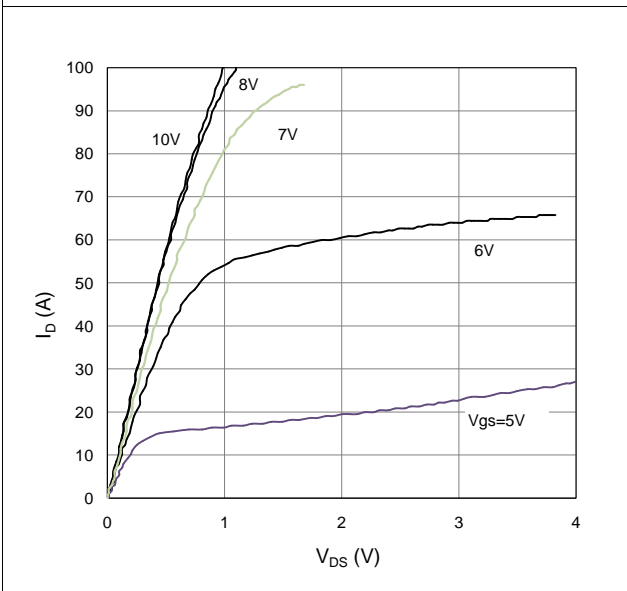


Figure 2. On-Resistance vs. Gate-Source Voltage

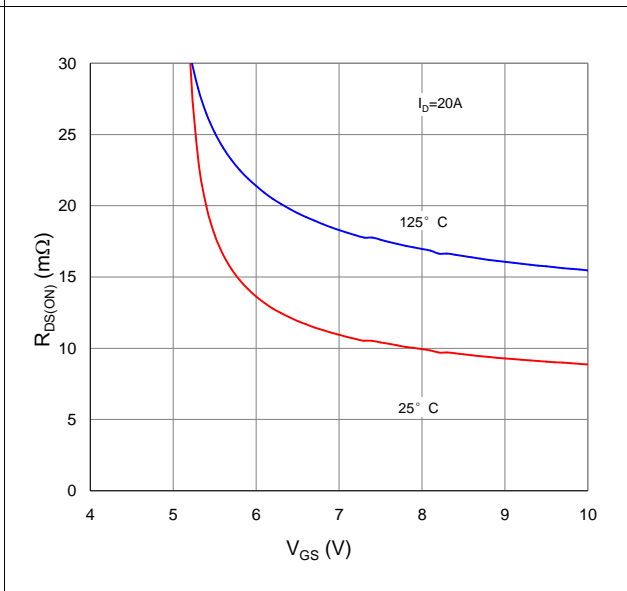


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

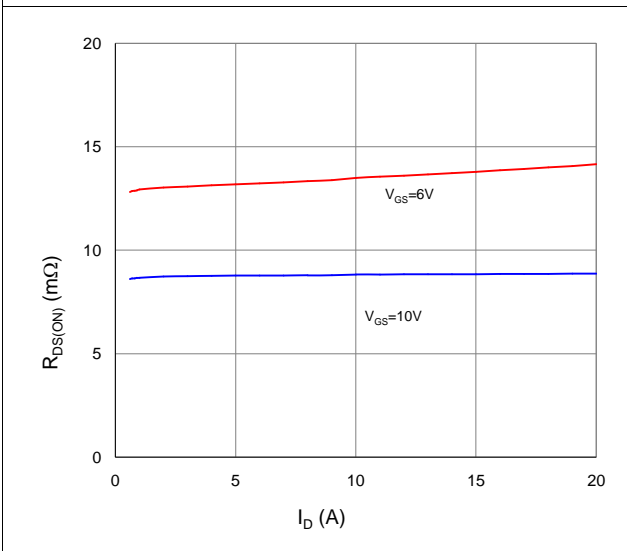


Figure 4. Normalized On-Resistance vs. Junction Temperature

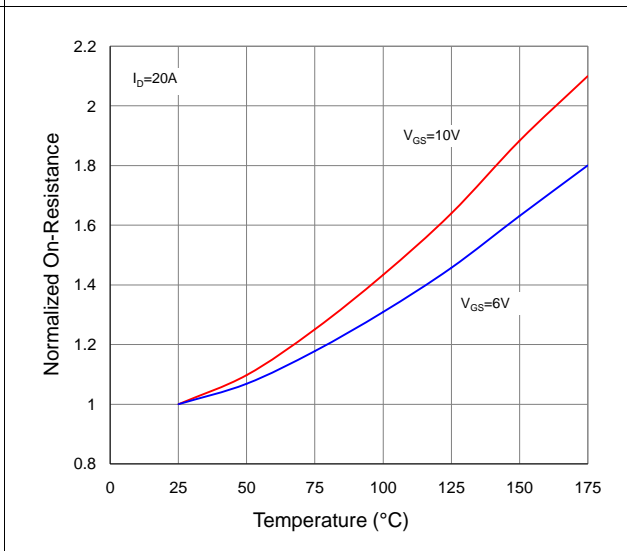


Figure 5. Typical Transfer Characteristics

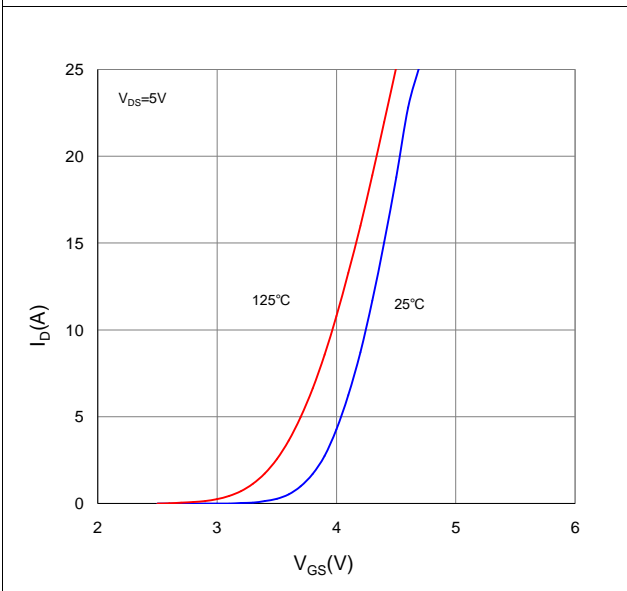


Figure 6. Typical Source-Drain Diode Forward Voltage

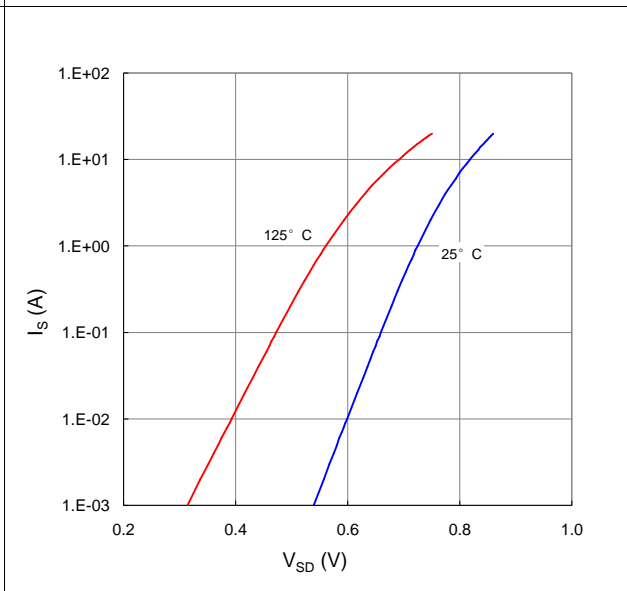


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

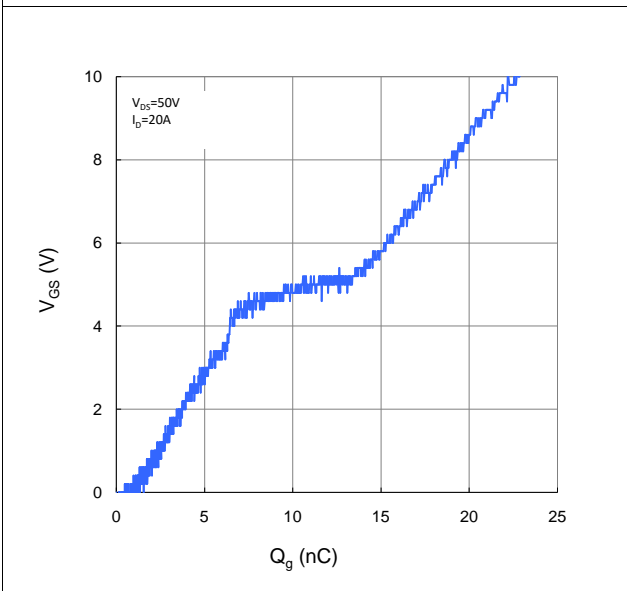


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

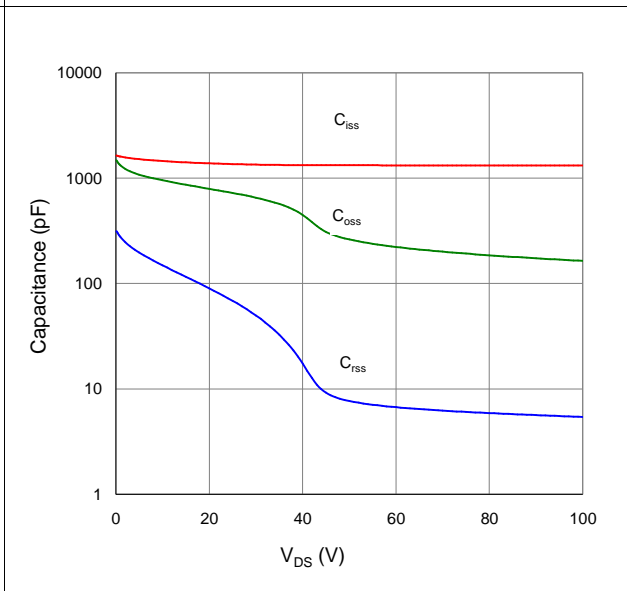


Figure 9. Maximum Safe Operating Area

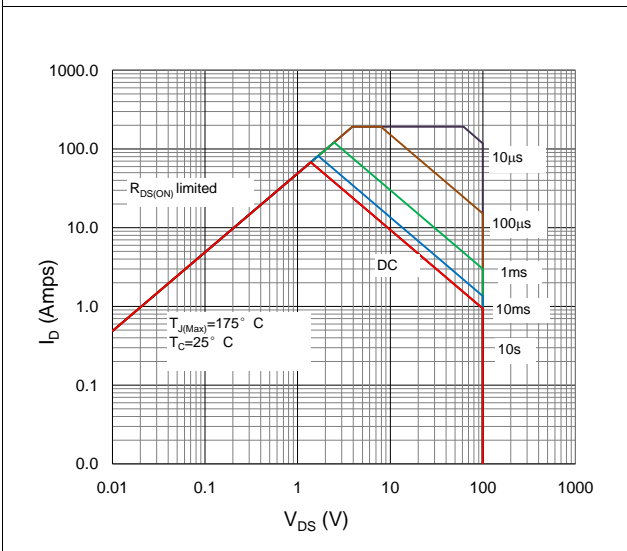


Figure 10. Maximum Drain Current vs. Case Temperature

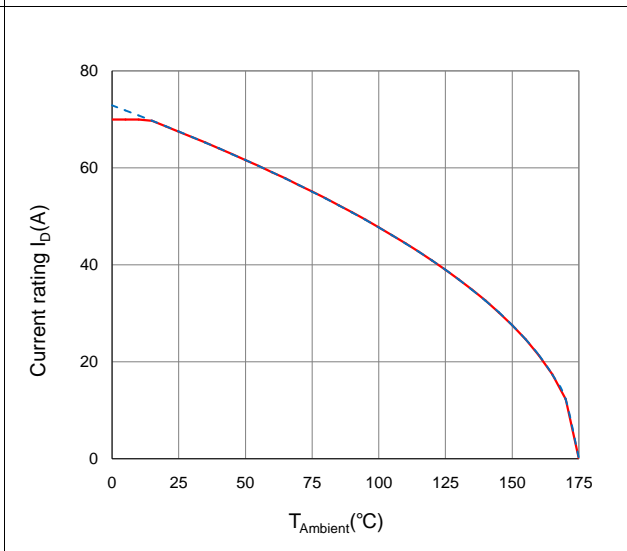
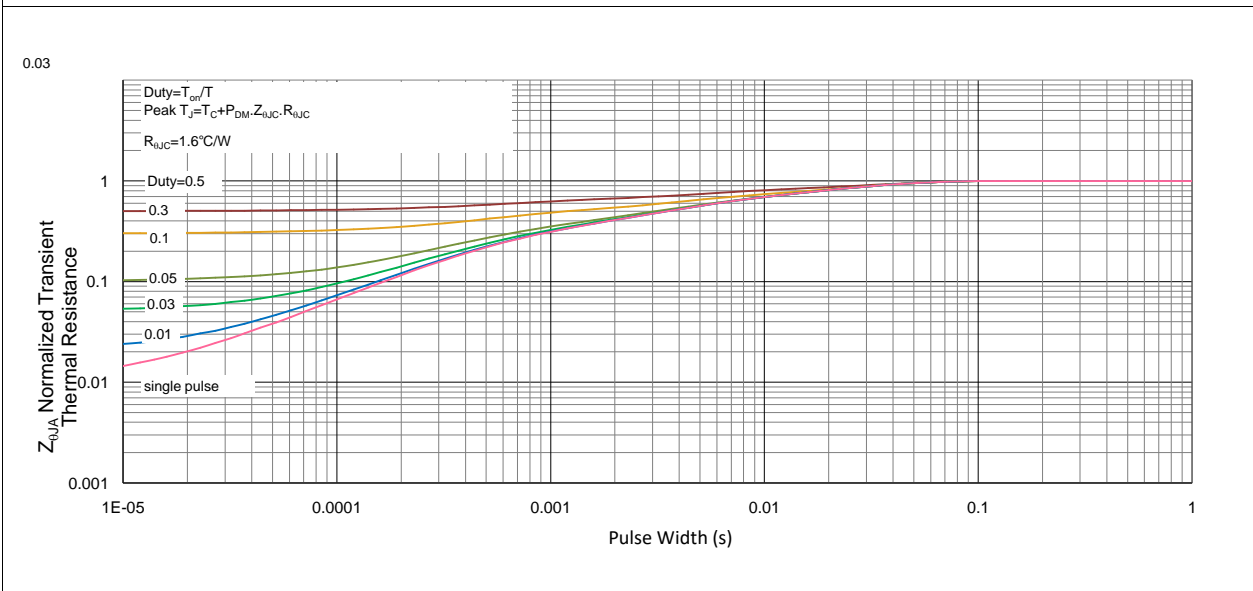
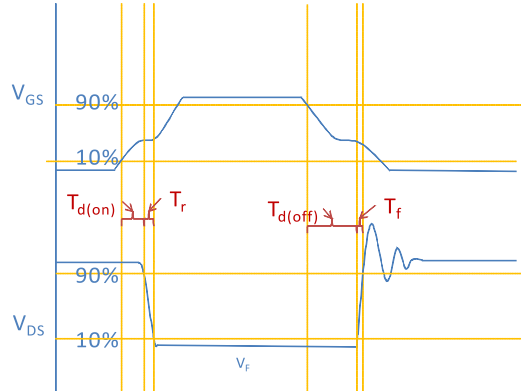
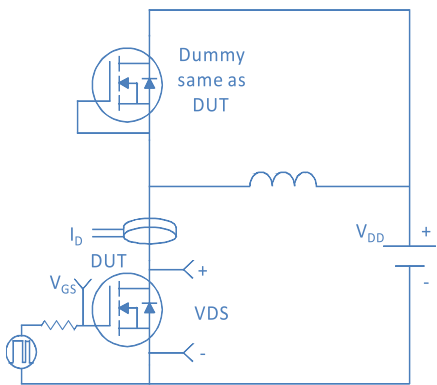


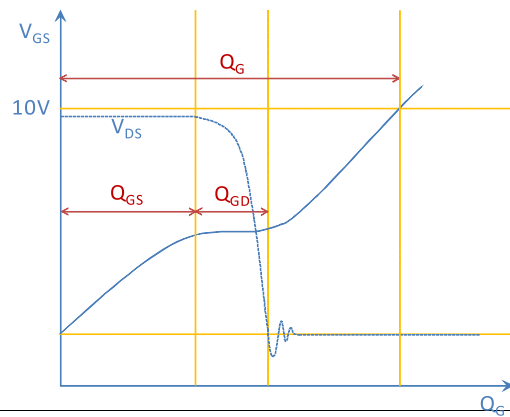
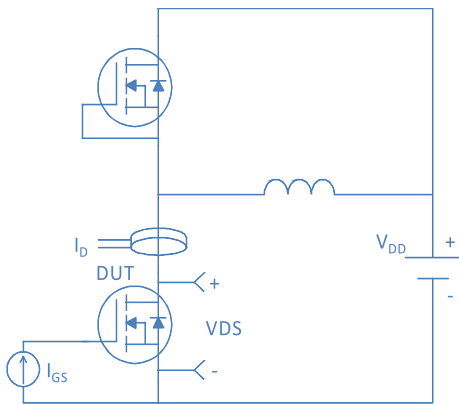
Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient



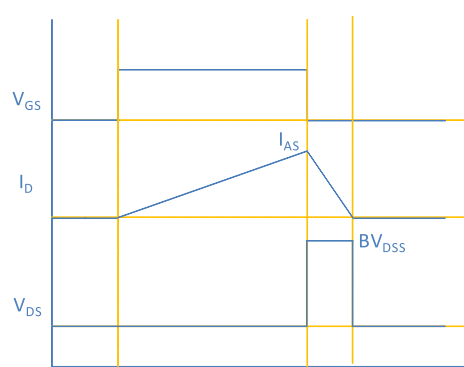
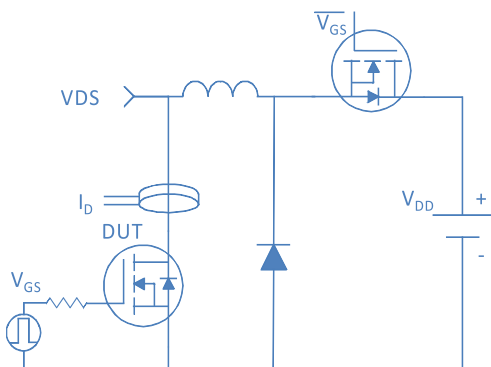
Inductive switching Test



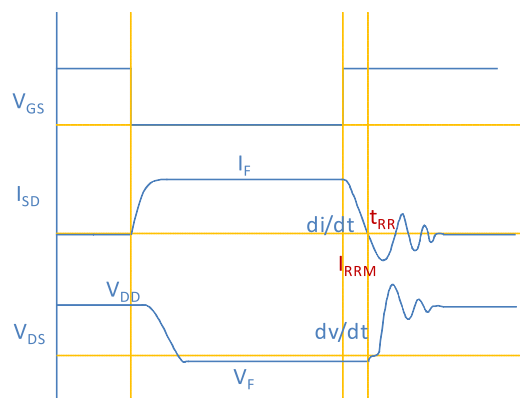
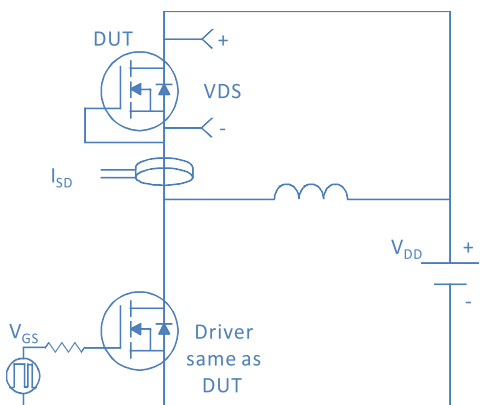
Gate Charge Test



Uclamped Inductive Switching (UIS) Test

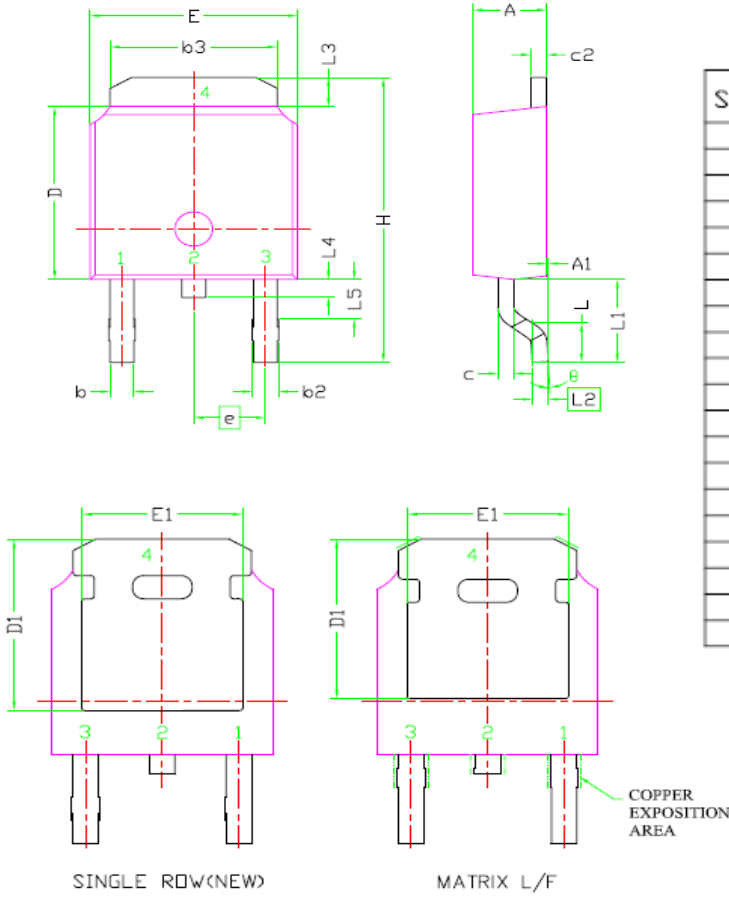


Diode Recovery Test



Package Outline

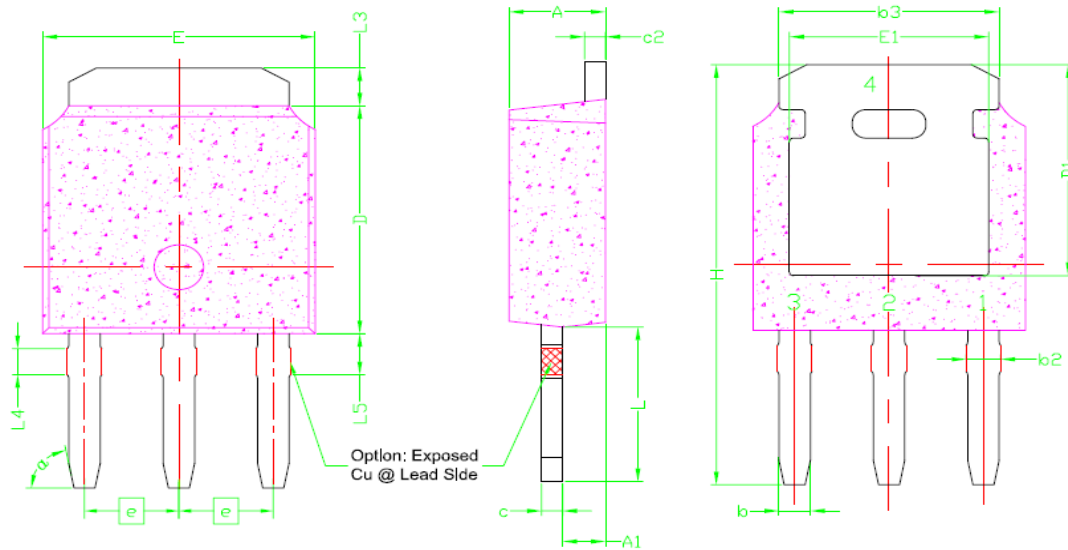
TO-252, 2 leads



| SYMBOL   | DIMENSIONAL REQMTS |       |       |
|----------|--------------------|-------|-------|
|          | MIN                | NOM   | MAX   |
| E        | 6.40               | 6.60  | 6.731 |
| L        | 1.40               | 1.52  | 1.77  |
| L1       | 2.743 REF          |       |       |
| L2       | 0.508 BSC          |       |       |
| L3       | 0.89               | --    | 1.27  |
| L4       | 0.64               | --    | 1.01  |
| L5       | --                 | --    | --    |
| D        | 6.00               | 6.10  | 6.223 |
| H        | 9.40               | 10.00 | 10.40 |
| b        | 0.64               | 0.76  | 0.88  |
| b2       | 0.77               | 0.84  | 1.14  |
| b3       | 5.21               | 5.34  | 5.46  |
| e        | 2.286 BSC          |       |       |
| A        | 2.20               | 2.30  | 2.38  |
| A1       | 0                  | --    | 0.127 |
| c        | 0.46               | 0.50  | 0.60  |
| c2       | 0.46               | 0.50  | 0.58  |
| D1       | 5.21               | --    | --    |
| E1       | 4.40               | --    | --    |
| $\theta$ | 0°                 | --    | 10°   |

Package Outline

TO-251, 3leads



| SYMBOL | DIMENSIONAL REQMTS |       |       |
|--------|--------------------|-------|-------|
|        | MIN                | NOM   | MAX   |
| E      | 6.40               | 6.60  | 6.731 |
| L      | 3.98               | 4.13  | 4.28  |
| L3     | 0.89               | --    | 1.27  |
| L4     | 0.698 REF          |       |       |
| L5     | 0.972              | 1.099 | 1.226 |
| D      | 6.00               | 6.10  | 6.223 |
| H      | 11.05              | 11.25 | 11.45 |
| b      | 0.64               | 0.76  | 0.88  |
| b2     | 0.77               | 0.84  | 1.14  |
| b3     | 5.21               | 5.34  | 5.46  |
| e      | 2.286 BSC          |       |       |
| A      | 2.20               | 2.30  | 2.38  |
| A1     | 0.89               | 1.04  | 1.15  |
| c      | 0.46               | 0.50  | 0.60  |
| c2     | 0.46               | 0.50  | 0.60  |
| D1     | 5.10               | --    | --    |
| E1     | 4.40               | --    | --    |
| a      | 79° REF            |       |       |